



## **CyberOptics Demonstrates Humidity Measurement Sensor for Critical Semiconductor Processes**

*Auto Multi Sensor improves fab yields by wirelessly measuring humidity, leveling and vibration in real-time*

**Minneapolis, MN— Feb. 2017** — CyberOptics® Corporation (NASDAQ: CYBE), a leading global developer and manufacturer of high precision 3D sensing technology solutions, announces it will demonstrate its ReticleSense® Auto Multi Sensors (AMSR) – the world’s most efficient and effective wireless measurement devices for semiconductor fabs and equipment OEMs at SPIE at the San Jose Convention Center, Feb. 26 – March 3, in booth #326.

At SPIE, CyberOptics will showcase its AMSR that measure leveling, vibration, and relative humidity (RH) in an all-in-one wireless real-time device. The AMSR can quickly capture multiple measurements in all locations of the reticle environment, saving equipment engineers or process engineer’s time and expense.

The CyberOptics’ booth will also feature the ReticleSense Airborne Particle Sensors (APSR, APSRQ) that speeds equipment set-up and long-term yields in semiconductor fabs by wirelessly monitoring airborne particles in real-time. In addition to small particles, the new large particle detecting and measurement functionality covers a range of sizes with four bins for particles larger than 2, 5, 10 and 30 microns.

### **About the WaferSense® and ReticleSense® Line**

The WaferSense measurement portfolio including the Auto Leveling System (ALS), the Auto Gapping System (AGS), the Auto Vibration System (AVS), the Auto Teaching System (ATS), the Airborne Particle Sensor (APS), the advanced Airborne Particle Sensor (APS2) and the new Auto Multi Sensor (AMS) are available in various wafer shaped form factors depending on the device, including 150mm, 200mm and 300mm wafer sizes. The ReticleSense measurement portfolio including the Airborne Particle Sensor (APSR & APSRQ) and next-generation APS2, the Auto Leveling System (ALSR) and the Auto Multi Sensor (AMSR) are available in a reticle shaped form factor.

For more information about the entire line of CyberOptics solutions please visit [www.cyberoptics.com](http://www.cyberoptics.com).

### **About CyberOptics**

CyberOptics Corporation (NASDAQ: CYBE) is a leading global developer and manufacturer of high precision sensing technology solutions. CyberOptics sensors are being used in general purpose metrology and 3D scanning, surface mount technology (SMT) and semiconductor markets to significantly improve yields and productivity. By leveraging its leading edge technologies, the company has strategically established itself as a global leader in high precision 3D sensors, allowing CyberOptics to further increase its penetration of its key vertical segments. Headquartered in Minneapolis, Minnesota, CyberOptics conducts worldwide operations through its facilities in North America, Asia and Europe.

Statements regarding the Company's anticipated performance are forward-looking and therefore involve risks and uncertainties, including but not limited to: market conditions in the global SMT and semiconductor capital equipment industries; increasing price competition and price pressure on our product sales, particularly our SMT systems; the level of orders from our OEM customers; the availability of parts required to meet customer orders; unanticipated product development challenges; the effect of world events on our sales, the majority of which are from foreign customers; rapid changes in technology in the electronics markets; product introductions and pricing by our competitors; the success of our 3D technology initiatives, including CyberGage360, and other factors set forth in the Company's filings with the Securities and Exchange Commission.

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